

KB CSLNM1.14

OSRAM OSTAR® Projection Compact

Compact light source with isolated heat sink for improved heat dissipation and high current chip technology for increased light output.



Applications

- Head-Up Display LED & Laser
- Projection Home LED & Laser

Features:

- Package: white molded SMD ceramic package
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: $\lambda_{\text{dom}} = 455 \text{ nm}$ (● blue)
- Corrosion Robustness Class: 3A
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

Ordering Information

Type	Total radiant flux ¹⁾ $I_F = 1000 \text{ mA}$ Φ_E	Ordering Code
KB CSLNM1.14-3V6A-46	900 ... 1400 mW	Q65112A3602
KB CSLNM1.14-5A8A-23	1120 ... 1800 mW	Q65113A1588

Maximum Ratings

Parameter	Symbol		Values
Surge Current			
Operating Temperature	T_{op}	min.	-40 °C
		max.	125 °C
Storage Temperature	T_{stg}	min.	-40 °C
		max.	125 °C
Junction Temperature	T_j	max.	150 °C
Forward current $T_s = 25\text{ °C}$	I_F	min.	40 mA
		max.	3000 mA
Forward current pulsed $D = 0.5 ; T_s = 25\text{ °C}$	$I_{F\ pulse}$	max.	4000 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV

Characteristics

$I_F = 1000 \text{ mA}$; $T_S = 25 \text{ °C}$

Parameter	Symbol		Values
Peak Wavelength	λ_{peak}	typ.	450 nm
Dominant Wavelength ²⁾ $I_F = 1000 \text{ mA}$	λ_{dom}	min. typ. max.	445 nm 455 nm 465 nm
Viewing angle at 50% I_V	2ϕ	typ.	120 °
Radiating surface	A_{color}	typ.	1 x 1 mm ²
Partial Flux acc. CIE 127:2007	$\Phi_{E/V, 120^\circ}$	typ.	0.76
Forward Voltage ³⁾ $I_F = 1000 \text{ mA}$	V_F	min. typ. max.	2.75 V 3.00 V 3.50 V
Real thermal resistance junction/solderpoint ⁴⁾	$R_{\text{thJS real}}$	typ. max.	4.1 K / W 4.9 K / W
Electrical thermal resistance junction/solderpoint ⁴⁾ with efficiency $\eta_e = 33 \%$	$R_{\text{thJS elec.}}$	typ. max.	2.7 K / W 3.3 K / W

Brightness Groups

Group	Total radiant flux ¹⁾ $I_F = 1000 \text{ mA}$ min. Φ_E	Total radiant flux ¹⁾ $I_F = 1000 \text{ mA}$ max. Φ_E
3V	900 mW	1000 mW
4V	1000 mW	1120 mW
5A	1120 mW	1250 mW
6A	1250 mW	1400 mW
7A	1400 mW	1590 mW
8A	1590 mW	1800 mW

Wavelength Groups

Group	Dominant Wavelength ²⁾ $I_F = 1000 \text{ mA}$ min. λ_{dom}	Dominant Wavelength ²⁾ $I_F = 1000 \text{ mA}$ max. λ_{dom}
2	445 nm	449 nm
3	449 nm	453 nm
4	453 nm	457 nm
5	457 nm	461 nm
6	461 nm	465 nm

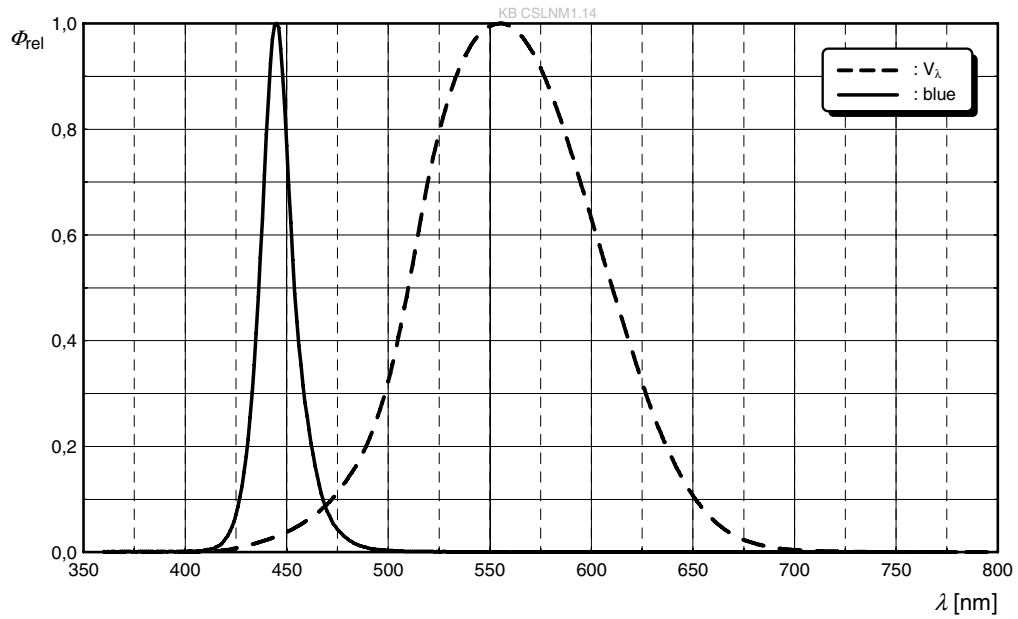
Group Name on Label

Example: 3V-2

Brightness	Wavelength
3V	2

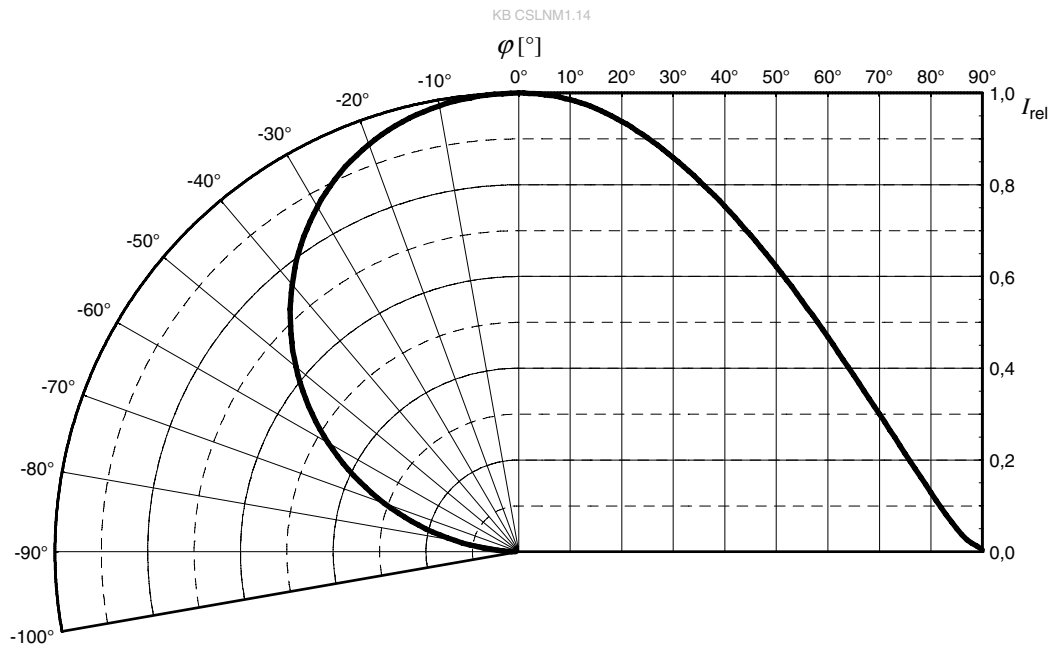
Relative Spectral Emission ⁵⁾

$\Phi_{rel} = f(\lambda); I_F = 1000 \text{ mA}; T_J = 25 \text{ }^\circ\text{C}$



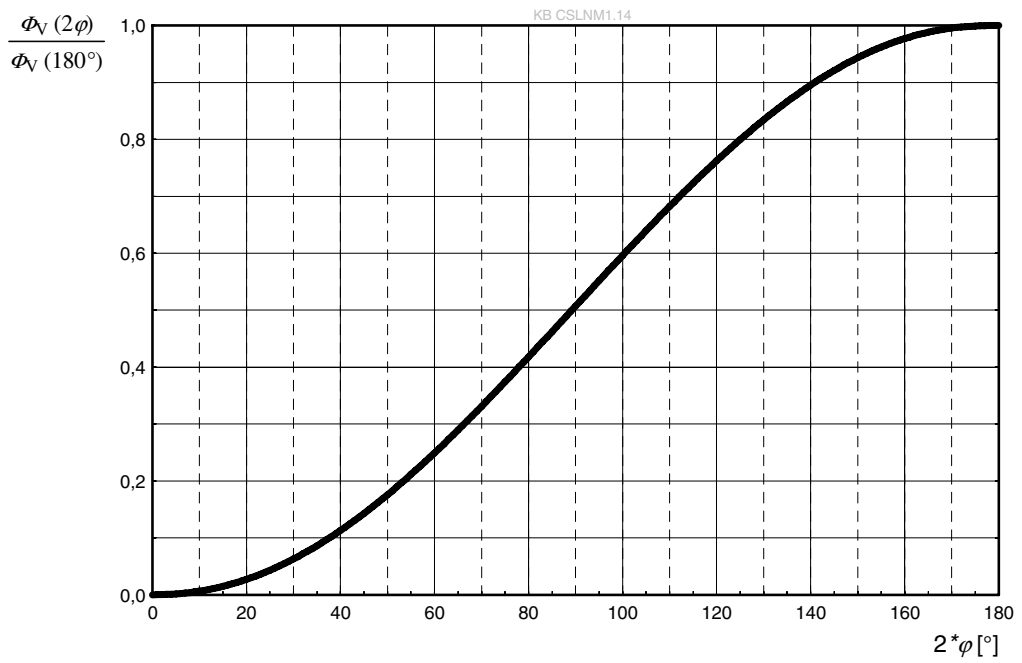
Radiation Characteristics ⁵⁾

$I_{rel} = f(\phi); T_J = 25 \text{ }^\circ\text{C}$



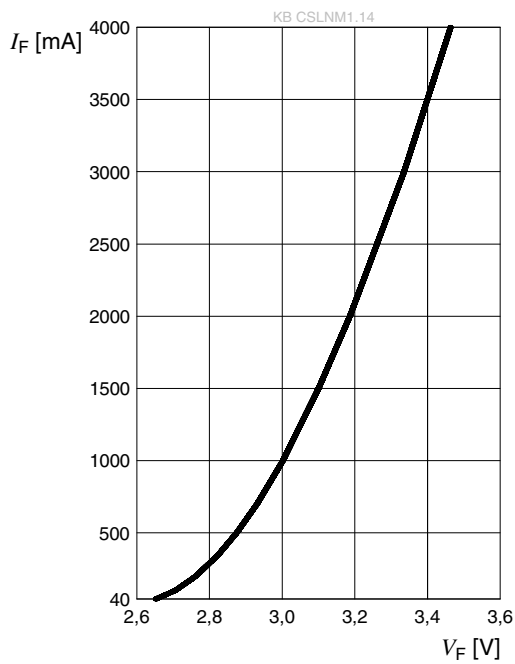
Relative Partial Flux 5)

$$\Phi_E(2\varphi)/\Phi_E(180^\circ) = f(\varphi); T_j = 25^\circ\text{C}$$



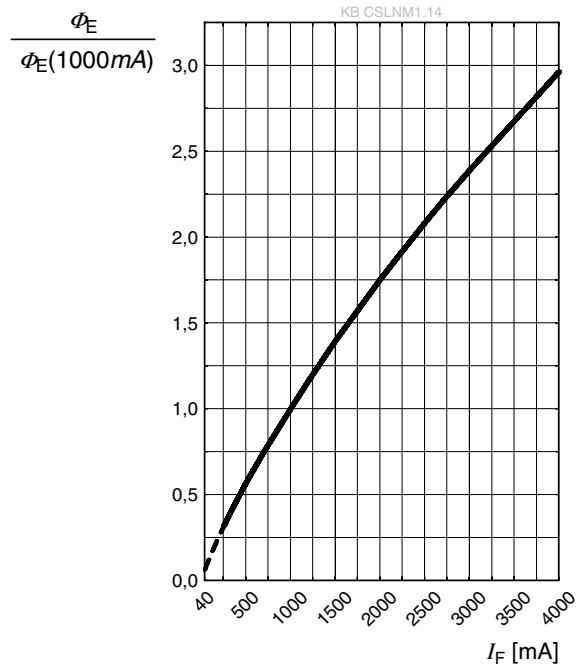
Forward current 5), 6)

$I_F = f(V_F); T_J = 25\text{ }^\circ\text{C}$



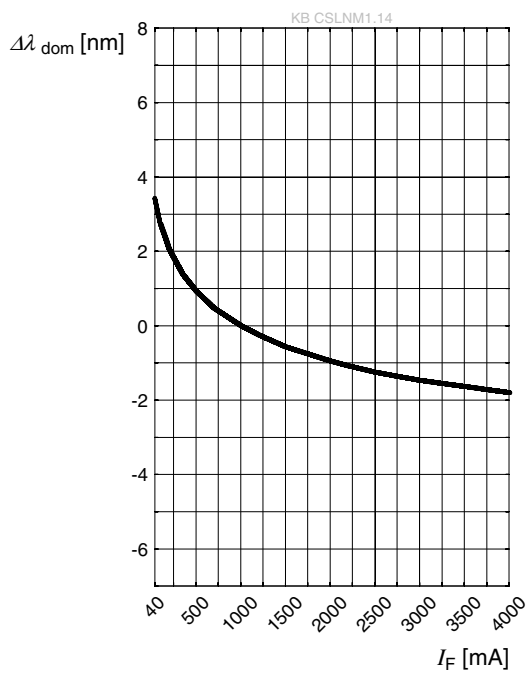
Relative Radiant Power 5), 6)

$\Phi_E / \Phi_E(1000\text{ mA}) = f(I_F); T_J = 25\text{ }^\circ\text{C}$



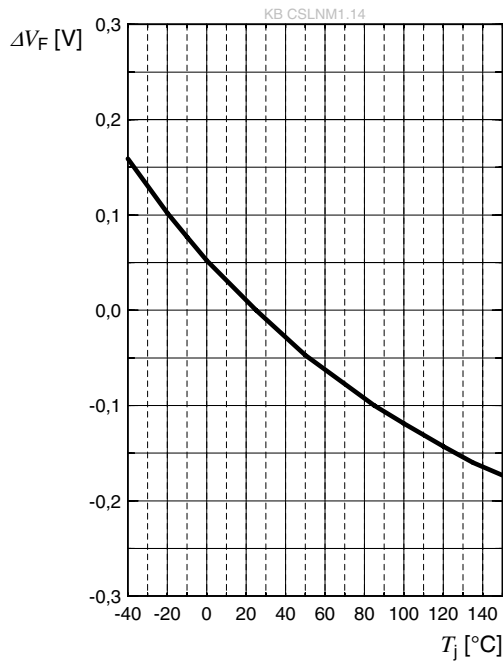
Dominant Wavelength 5)

$\Delta\lambda_{\text{dom}} = f(I_F); T_J = 25\text{ }^\circ\text{C}$



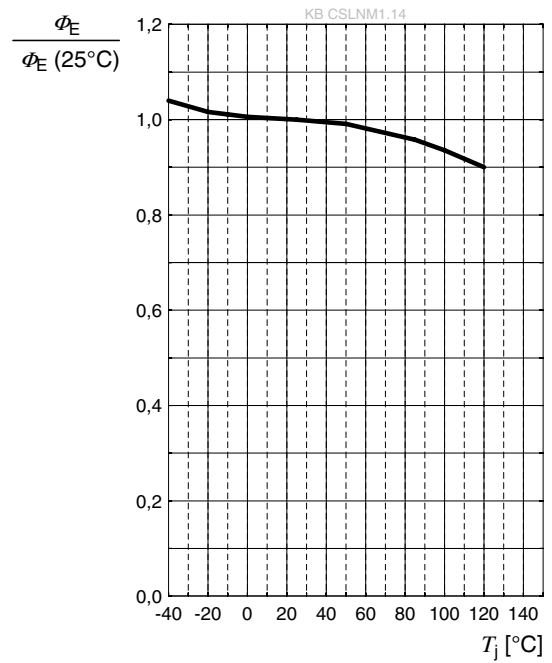
Forward Voltage ⁵⁾

$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 1000\text{ mA}$$



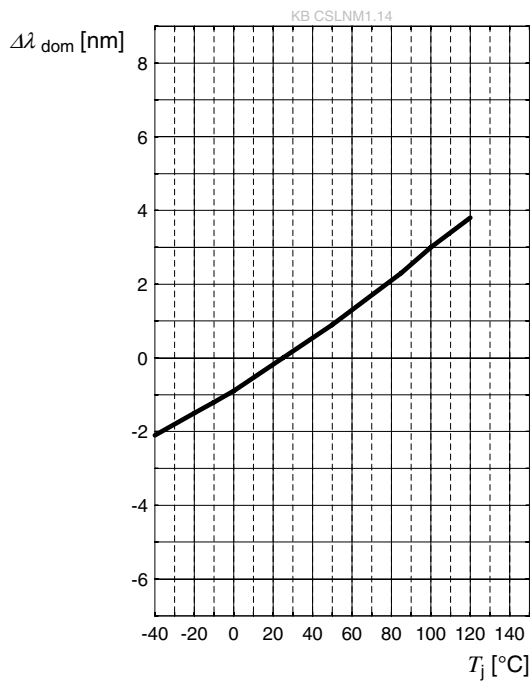
Relative Radiant Power ⁵⁾

$$\Phi_E / \Phi_E(25\text{ °C}) = f(T_j); I_F = 1000\text{ mA}$$



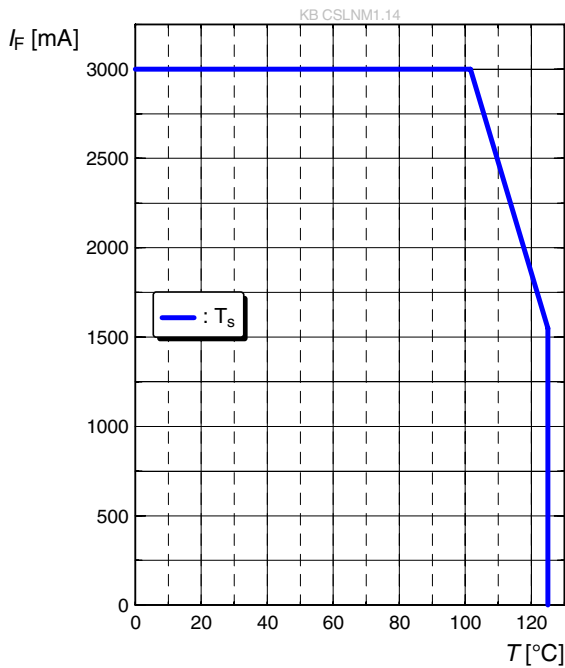
Dominant Wavelength ⁵⁾

$$\Delta \lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25\text{ °C}) = f(T_j); I_F = 1000\text{ mA}$$



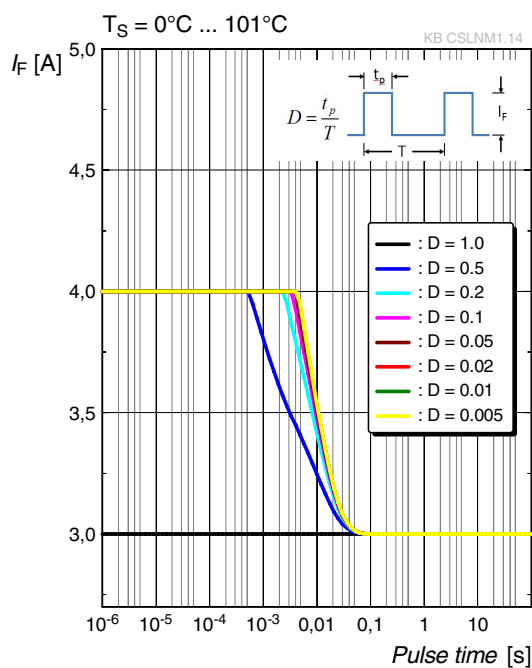
Max. Permissible Forward Current

$I_F = f(T)$



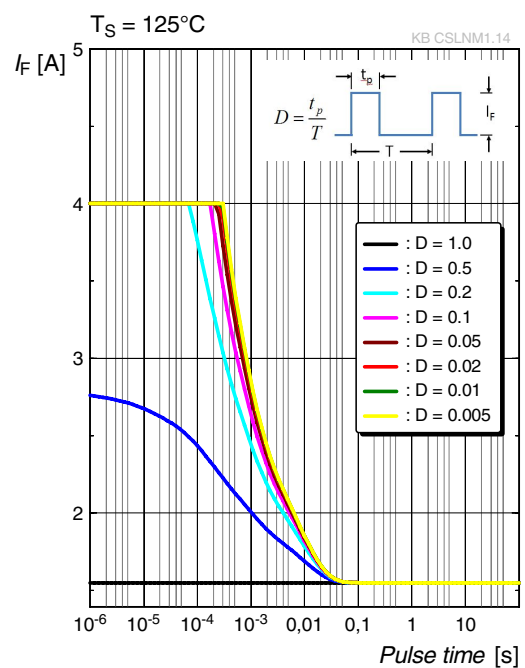
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle



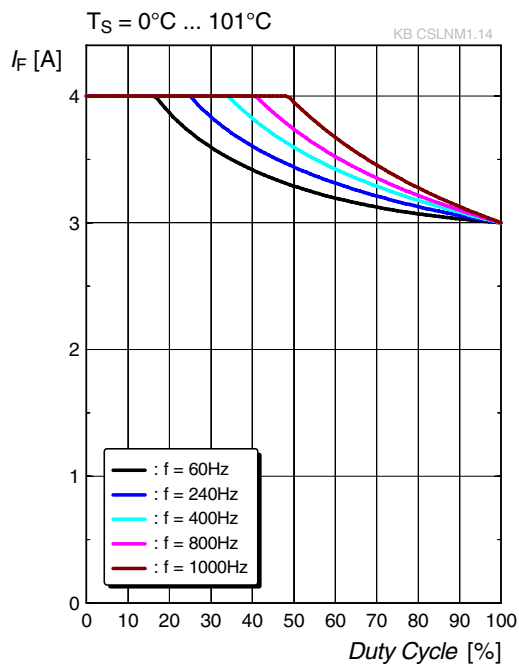
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle



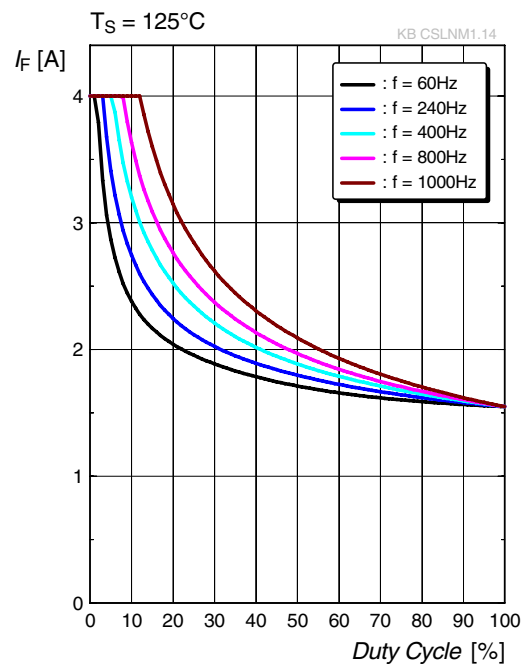
Permissible F. Handling Capability

f: Frequency

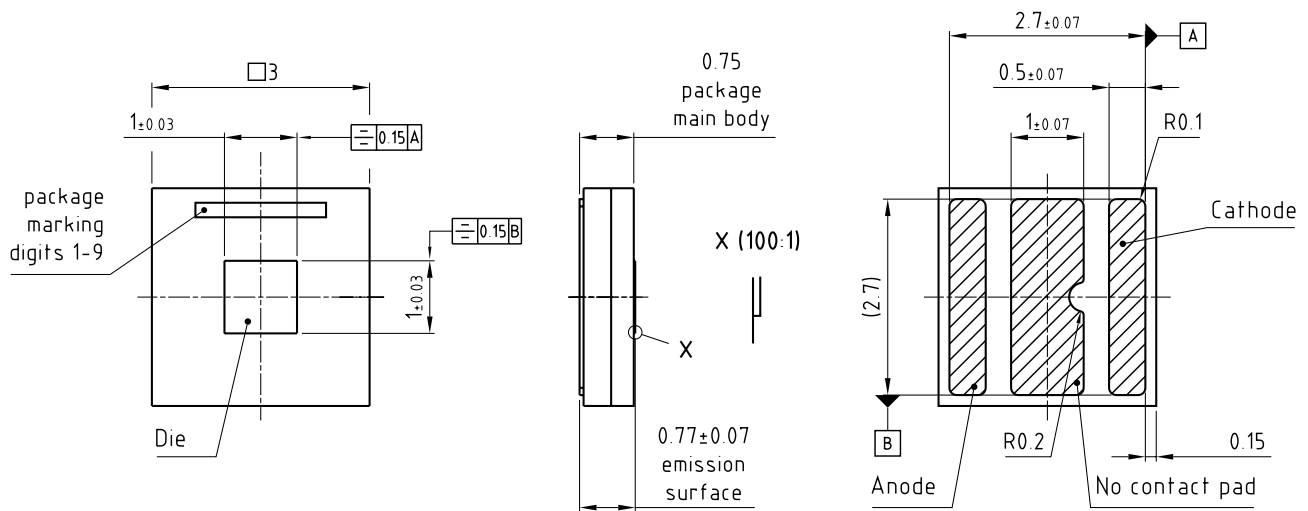



Permissible F. Handling Capability

f: Frequency



Dimensional Drawing ⁷⁾



general tolerance ± 0.1
 lead finish Au 

C63062-A4 312-A3 -04

Further Information:

Approximate Weight: 36.0 mg

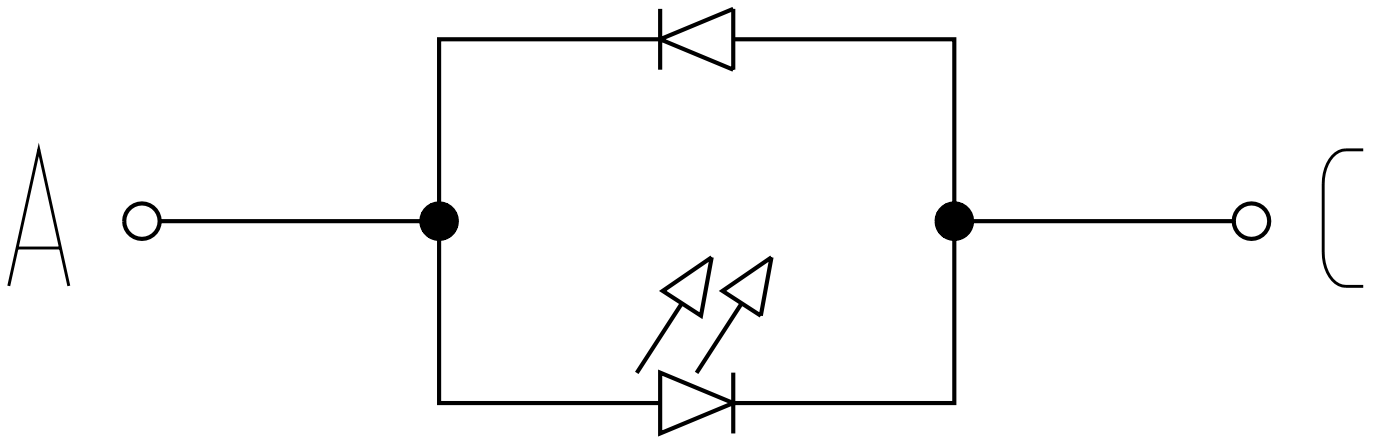
Package marking: Cathode

Corrosion test: Class: 3A

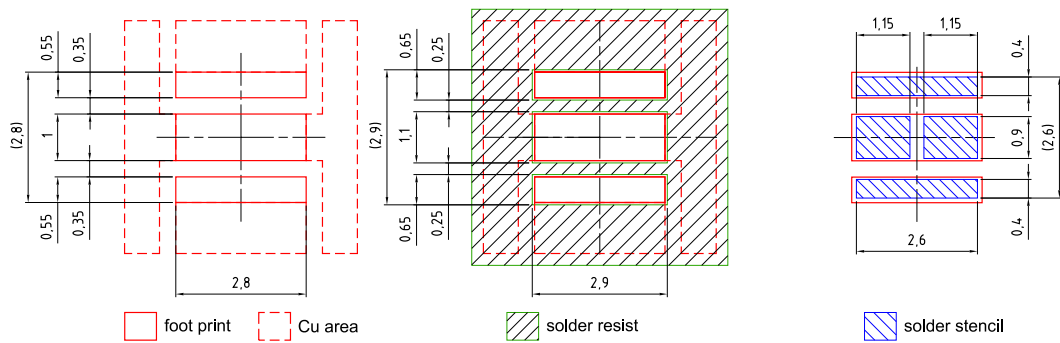
Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC 60068-2-43)

Electrical Internal Circuit

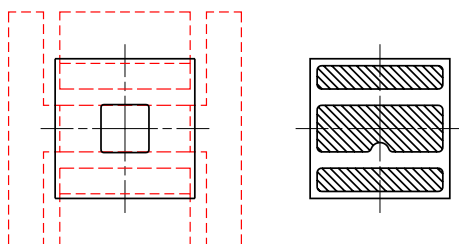
ESD Protection



Recommended Solder Pad ⁷⁾



Component Location on Pad

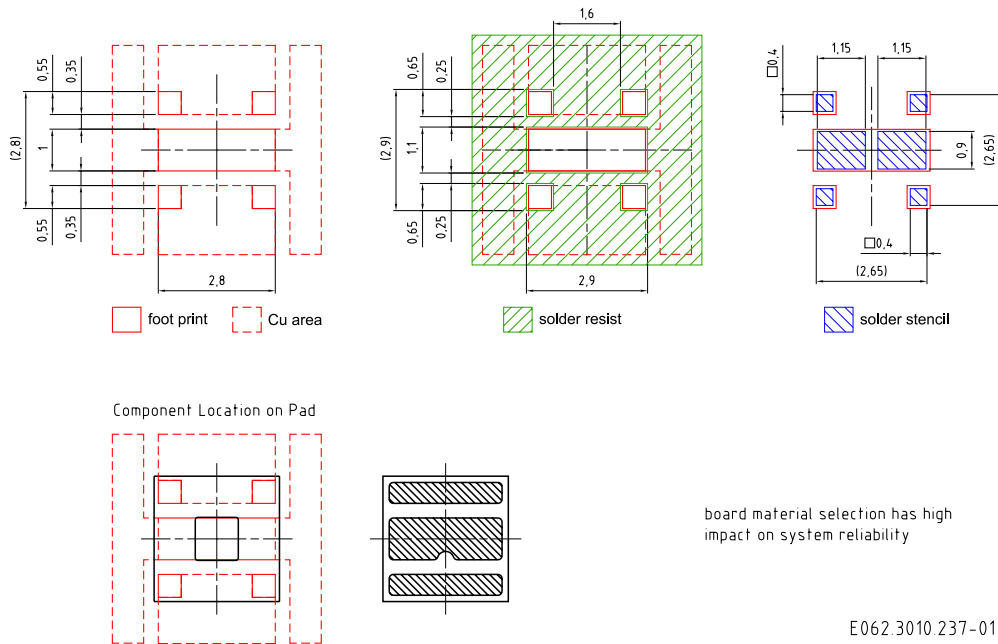


board material selection has high impact on system reliability

E062.3010.208 -02

Recommended Solder Pad 7)

Alternative Solder pad design for pedestal MCPCB

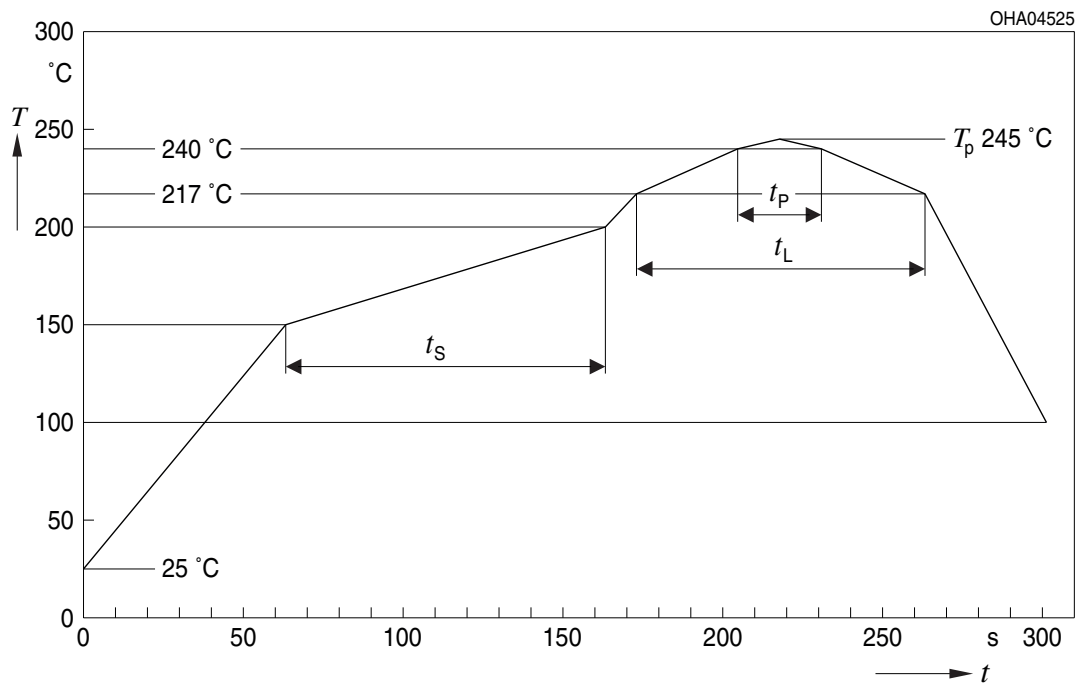


E062.3010.237-01

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for any kind of wet cleaning or ultrasonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

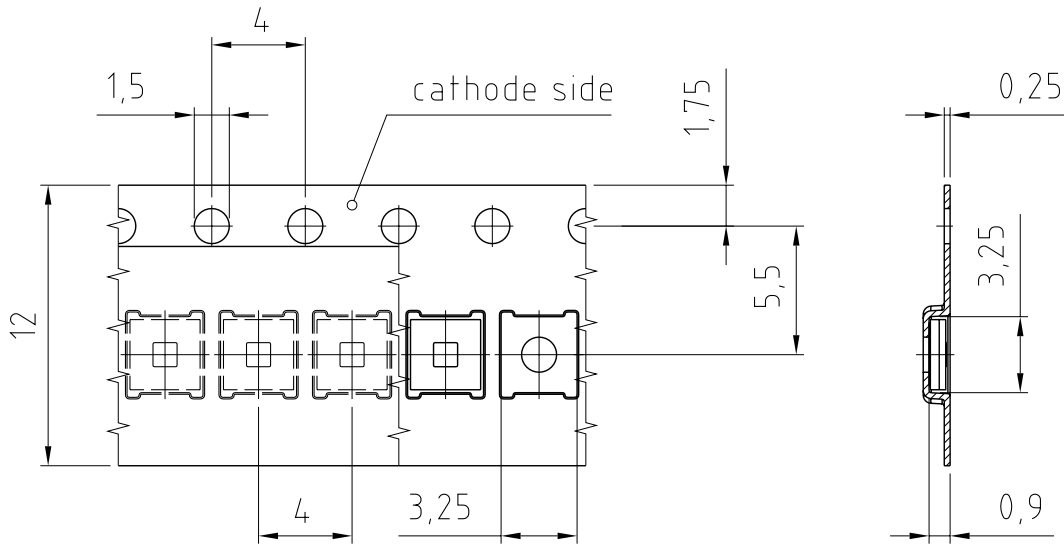


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁷⁾



C63062-A4312-B3-03

Tape and Reel ⁸⁾



Reel Dimensions

A	W	N_{min}	W_1	W_{2max}	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	1000

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890 (9D) D/C: 1234

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

ML Temp ST
X XXX °C X

Pack: RXX
DEMY XXX
X_X123_1234.1234 X

The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and name, a part number 'LX XXXX', and a bin number 'BIN1: XX-XX-X-XXX-X'. It features three main barcode sections: a top one for batch number, a middle one for lot number and date code, and a bottom one for product number, quantity, and group. A 'RoHS Compliant' logo is present. A 'Moisture Sensitive Device' symbol (a circle with a diagonal line and three drops) is shown next to 'ML Temp ST X XXX °C X'. A QR code is located on the right side. A 'Pack: RXX', 'DEMY XXX', and 'X_X123_1234.1234 X' are listed at the bottom right. A large 'EXAMPLE' watermark is overlaid diagonally across the label.

OHA04563

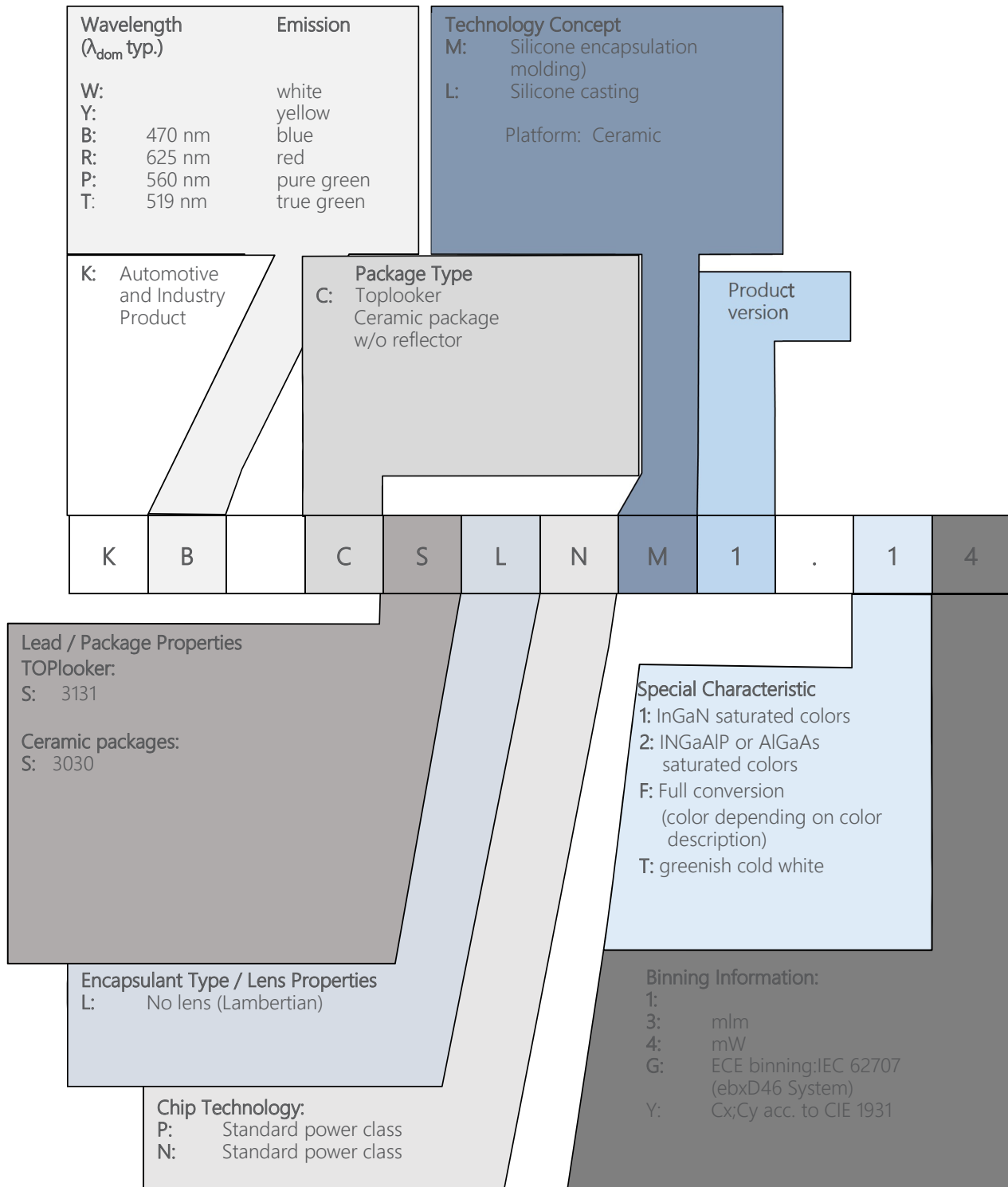
Dry Packing Process and Materials ⁷⁾



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers avoid device exposure to aggressive substances during storage, production, and use.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ± 0.5 nm and an expanded uncertainty of ± 1 nm (acc. to GUM with a coverage factor of $k = 3$).
- 3) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of $k = 3$).
- 4) **Thermal Resistance:** $R_{th\ max}$ is based on statistic values (6σ).
- 5) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 6) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 7) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 8) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.7	2019-01-07	Additional Information
1.8	2020-07-17	Ordering Information

Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product
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此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，不含有毒有害物质或元素。

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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